查<mark>询"EDMS86104"供</mark>应商 FAIRCHILD

SEMICONDUCTOR®

FDMS86104 N-Channel PowerTrench[®] MOSFET 100 V, 16 A, 24 mΩ

Features

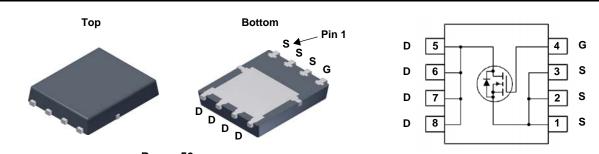
- Max $r_{DS(on)}$ = 24 m Ω at V_{GS} = 10 V, I_D = 7 A
- Max $r_{DS(on)}$ = 39 m Ω at V_{GS} = 6 V, I_D = 5.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant



Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		16		
	-Continuous (Silicon limited)	T _C = 25 °C		39	^	
	-Continuous	T _A = 25 °C	(Note 1a)	7	Α	
	-Pulsed			30		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	96	mJ	
P _D	Power Dissipation	T _C = 25 °C		73		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.7	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86104	FDMS86104	Power 56	13 "	12 mm	3000 units

Source Breakdown Voltage vn Voltage Temperature nt e Voltage Drain Current cource Leakage Current	I _D = 250 μA, V _{GS} = 0 V				
vn Voltage Temperature nt e Voltage Drain Current	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$				
vn Voltage Temperature nt e Voltage Drain Current	5 . 00	100			V
-	I_D = 250 μ A, referenced to 25 °C		66		mV/°C
ource Leakage Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
Caroo Ecanago Caron	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
s					
-	$V_{} = V_{} = 1_{} = 250 \text{ m}$	2	2.0	4	V
	V _{GS} = V _{DS} , I _D = 200 μA	2	2.5	4	v
ure Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		-10		mV/°C
Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 7 A		20	24	
	V _{GS} = 6 V, I _D = 5.5 A		27	39	mΩ
	V _{GS} = 10 V, I _D = 7 A, T _J = 125 °C		33	40	
Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		18		S
eristics		·			
			694	923	pF
					pF
	t = 1 MHz				pF
					Ω
9	V _{DD} = 50 V, I _D = 7 A,		3.5	10	ns ns
Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω			26	ns
					ns
					nC
-				9	
-	$I_D = 7 A$				nC
orain "Miller" Charge			3		nC
de Characteristics					
Drain Diodo, Forward Voltago	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.7	1.2	- V
Drain Diode Forward voltage	$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.8	1.3	
			44	70	ns
Recovery Time Recovery Charge	— I _F = 7 A, di/dt = 100 A/μs				
	in to Source On Resistance Transconductance eristics pacitance apacitance teristics Delay Time Celay Time Celay	ource Threshold Voltage ure CoefficientIDDODOID $I_D = 250 \ \mu$ A, referenced to 25 °CIn to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 7 \ A$ VGS $= 10 \ V, \ I_D = 7 \ A, \ T_J = 125 \ °C$ Transconductance $V_{DS} = 10 \ V, \ I_D = 7 \ A$ Peristicspacitance $V_{DS} = 50 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ Prance $V_{DS} = 50 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ PristicsDelay Time $V_{DD} = 50 \ V, \ I_D = 7 \ A, \ V_{GS} = 10 \ V, \ R_{GEN} = 6 \ \Omega$ PeristicsDelay Time $V_{GS} = 0 \ V \ to 10 \ V, \ V_{DD} = 50 \ V, \ I_D = 7 \ A$ Prince $V_{GS} = 0 \ V \ to 5 \ V, \ I_D = 7 \ A$ Pristics $V_{GS} = 0 \ V \ to 5 \ V, \ I_D = 7 \ A$ Parane Charge $V_{GS} = 0 \ V \ to 5 \ V, \ I_D = 7 \ A$ Parane Charge $V_{GS} = 0 \ V \ to 5 \ V, \ I_D = 7 \ A$ Parane Diode Forward Voltage $V_{GS} = 0 \ V, \ I_S = 2 \ A$ Parane Diode Forward Voltage $V_{GS} = 0 \ V, \ I_S = 2 \ A$	ource Threshold Voltage ure Coefficient $I_D = 250 \ \mu$ A, referenced to 25 °Cain to Source On Resistance $V_{GS} = 10 \ V, I_D = 7 \ A$ $V_{GS} = 6 \ V, I_D = 5.5 \ A$ $V_{GS} = 10 \ V, I_D = 7 \ A, T_J = 125 \ °C$ Transconductance $V_{DS} = 10 \ V, I_D = 7 \ A$ eristics $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_D = 7 \ A$ apacitance apacitance $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_D = 7 \ A$ teristics $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_D = 7 \ A, I_D = 125 \ °C$ Delay Time $V_{DD} = 50 \ V, I_D = 7 \ A, V_{GS} = 10 \ V, R_{GEN} = 6 \ \Omega$ ac Charge $V_{GS} = 0 \ V \ to 10 \ V, V_{SS} = 10 \ V, R_{GEN} = 6 \ \Omega$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, V_{DD} = 50 \ V, I_D = 7 \ A, I_D = 7 \ A$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ ac Delay Time $V_{DD} = 50 \ V, I_D = 7 \ A$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ ac Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ be Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ be Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ be Charge $V_{GS} = 0 \ V \ to 5 \ V, I_D = 7 \ A$ be Drain Diode. Forward Voltage $V_{GS} = 0 \ V, I_S = 2 \ A \ (Note 2)$	ource Threshold Voltage ure Coefficient $I_D = 250 \ \mu$ A, referenced to 25 °C-10In to Source On Resistance $V_{GS} = 10 \ V, I_D = 7 \ A$ 20 $V_{GS} = 6 \ V, I_D = 5.5 \ A$ 27 $V_{GS} = 10 \ V, I_D = 7 \ A, T_J = 125 \ °C$ 33Transconductance $V_{DS} = 10 \ V, I_D = 7 \ A$ 18eristicsvacitance $V_{DS} = 50 \ V, V_{GS} = 0 \ V, I_D = 7 \ A$ 694apacitance $f = 1 \ MHz$ 8transfer Capacitance 0.5 8belay Time 0.5 14.3ac Charge $V_{GS} = 0 \ V, I_D = 7 \ A, V_{GS} = 0 \ V, I_D = 50 \ V, I_D = 50 \ V, I_D = 50 \ V, I_D = 7 \ A, V_{GS} = 0 \ V \ CGS = 0 \ V \ to 5 \ V, V_{DD} = 50 \ V, I_D = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 7 \ A, V_{DD} = 50 \ V, I_D = 7 \ A, V_{DD} = 7 \ A, J_{D} = 7 \ A \ A \ A \ A \ A \ A \ A \ A \ A \$	ource Threshold Voltage ure Coefficient $I_D = 250 \ \mu$ A, referenced to 25 °C -10 In to Source On Resistance $V_{GS} = 10 \ V, I_D = 7 \ A$ 20 24 VGS = 6 V, I_D = 5.5 \ A 27 39 VGS = 10 V, I_D = 7 \ A, T_J = 125 °C 33 40 Transconductance VDS = 10 V, I_D = 7 \ A, T_J = 125 °C 33 40 Pristics Pristics 694 923 apacitance VDS = 50 V, VGS = 0 V, f = 1 MHz 178 237 Transfer Capacitance VDS = 50 V, VGS = 0 V, f = 1 MHz 8 13 Delay Time 0.5 0.5 0.5 0.5 teristics Delay Time VDD = 50 V, I_D = 7 A, VGS = 10 V, R_{GEN} = 6 \Omega 14.3 26 0 = Charge VGS = 0 V to 10 V VGS = 0 V to 5 V 0.14.3 26 0 = Charge VGS = 0 V to 5 V VDD = 50 V, I_D = 7 A 3.2 10 0 = Charge VGS = 0 V to 5 V VDD = 50 V, I_D = 7 A 3.2 3 train "Miller" Charge VGS = 0 V, I_S = 2 A 0.07 1.2

3. Starting T_J = 25 °C, L = 3 mH, I_{AS} = 8 A, V_{DD} = 100 V, V_{GS} = 10 V

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查询"FDMS86104"供应商 Typical Characteristics T_{.1} = 25 °C unless otherwise noted 5 PULSE DURATION = 80 µs NORMALIZED DRAIN TO SOURCE ON-RESISTANCE V_{GS} = 10 V DUTY CYCLE = 0.5% MAX 4 V_{GS} = 4.5 \ _{GS} = 8 V $V_{GS} = 5 V$ 3 V_{GS} = 6.5 V V_{GS} - 8 V 2 $V_{GS} = 6.5 V$ V_{GS} = 5 V 1 V_{GS} = 10 V PULSE DURATION = 80 µs DUTY CYCLE = 0.5% MAX V_{GS} = 4.5 V 0 · 0 1 2 3 4 5 6 12 18 24 30 ID, DRAIN CURRENT (A) V_{DS}, DRAIN TO SOURCE VOLTAGE (V) Figure 1. On-Region Characteristics Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage 0.20 I_D = 7 A PULSE DURATION = 80 µs $I_D = 7 A$ DUTY CYCLE = 0.5% MAX V_{GS} = 10 V r_{DS(on)}, DRAIN TO T_J = 125 °C T_J = 25 °C 0.00└ 4 -25 0 50 75 100 125 150 25 5 6 7 8 9 10 TJ, JUNCTION TEMPERATURE (°C) V_{GS}, GATE TO SOURCE VOLTAGE (V) Figure 3. Normalized On-Resistance Figure 4. On-Resistance vs Gate to vs Junction Temperature Source Voltage 40 $V_{GS} = 0 V$ PULSE DURATION = 80 µs Is, REVERSE DRAIN CURRENT (A) DUTY CYCLE = 0.5% MAX 10 T_J = 150 °C $V_{DS} = 5 V$ 1 T_J = 150 °C T_J = 25 °C 0.1 T_J = 25 °C T_J = -55 °C 0.01 T_J = -55 °C 0.001└─ 0.0 0.2 0.4 0.6 0.8 1.0 1.2 3 5 6 4 V_{GS}, GATE TO SOURCE VOLTAGE (V) V_{SD}, BODY DIODE FORWARD VOLTAGE (V) Figure 5. Transfer Characteristics Figure 6. Source to Drain Diode Forward Voltage vs Source Current

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30

24

18

12

6

0 0

2.0

1.8

1.6

1.4 1.2

1.0 0.8

0.6 └─ -75

30

24

18

12

6

0 └ 2

ID, DRAIN CURRENT (A)

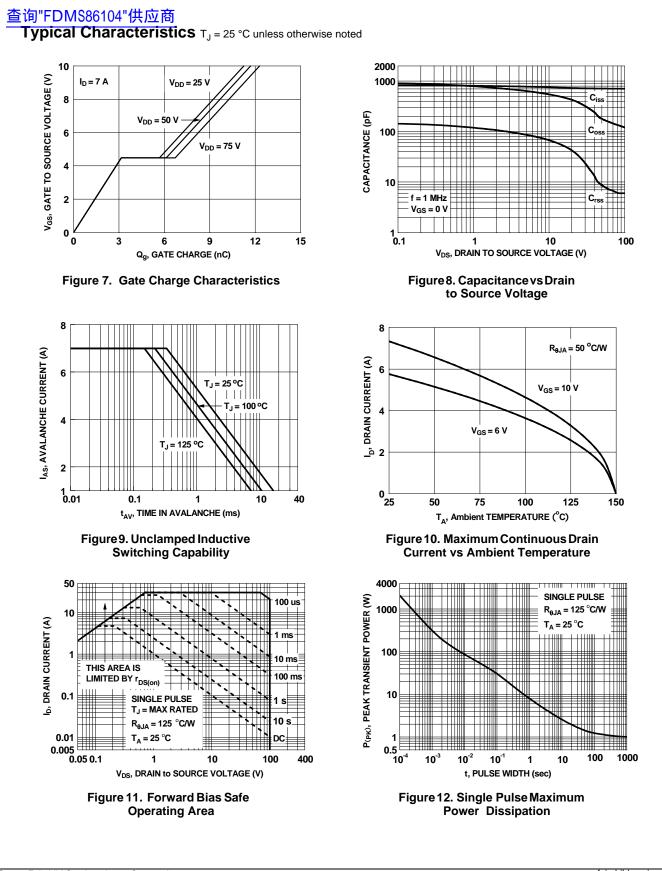
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NORMALIZED DRAIN TO SOURCE ON-RESISTANCE

ID, DRAIN CURRENT (A)

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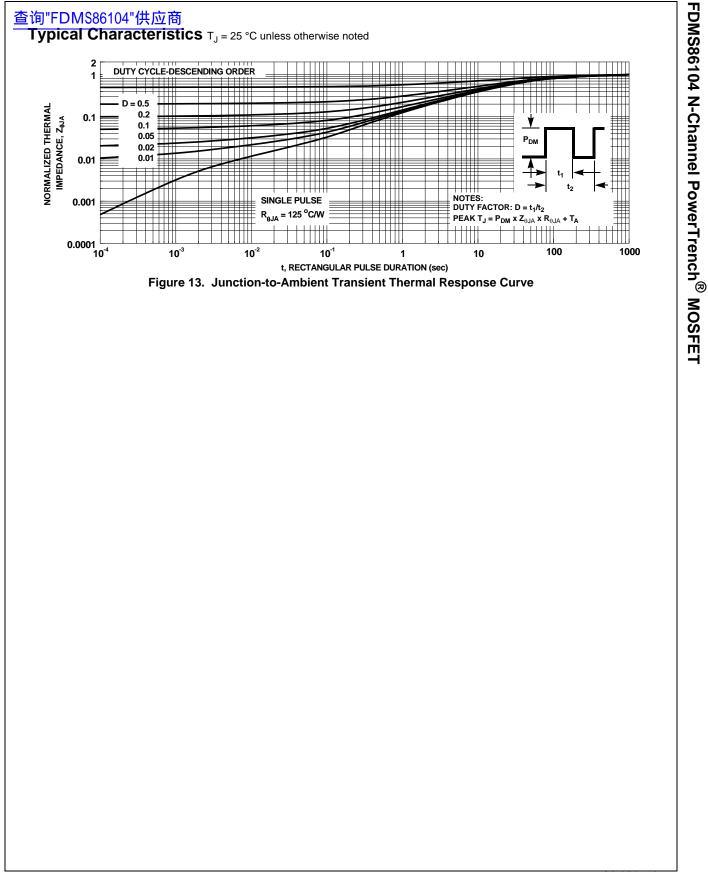


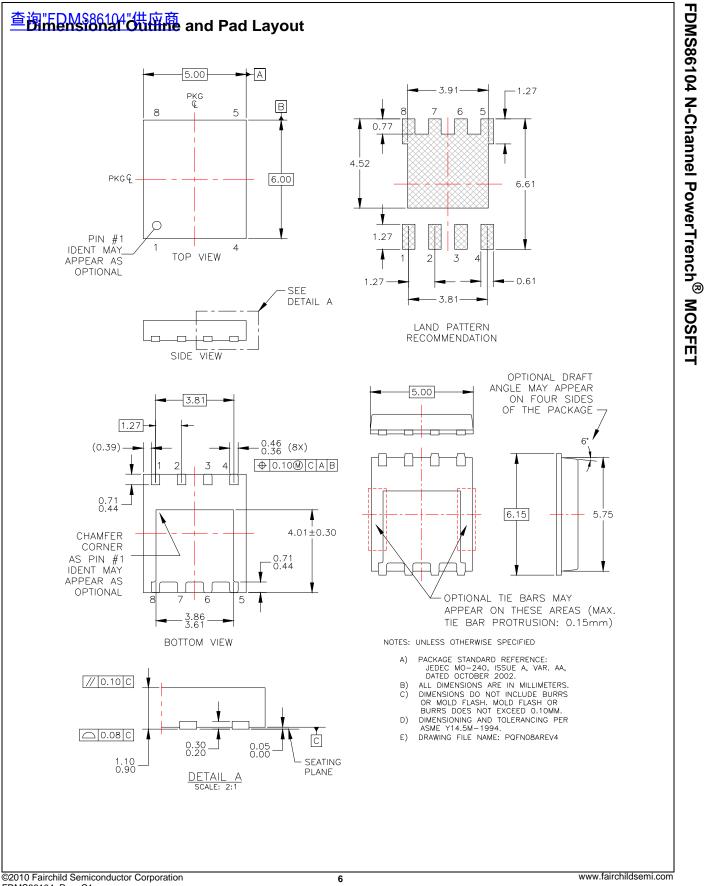
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